## (ACCIS 2019)

## The 8th Asian Conference on Colloid & Interface Science

Sept. 24-27, 2019

Pulchowk Campus, Institute of Engineering, Tribhuvan University, Lalitpur, Kathmandu, NEPAL



**REGISTRATION FORM (ACCIS 2019)** 

First Name:
Surname:
Title (Mr./Ms./Dr./Prof.):
Affiliation:
Address:
Country:
Email:
Presentation Type (Oral/Poster): []
Presentation title:
Symposium: Please select (√) appropriate symposium
Symposium 1: Principles of self-assembly, micelles & liquid crystals [ ]
Symposium 2: Nanoparticles, nanomaterials & structure-property relationship [ ]
Symposium 3: Soft materials, colloidal dispersions, gels, thin films, surfactants & polymers [ ]
Symposium 4: Biomimetic materials, drug discovery, drug delivery, nanomedicine & pharmacy [ ]
Symposium 5: Foam, bubbles, emulsions, microemulsion & applications of colloids [ ]
Symposium 6: Catalytic systems, fuel cells, supercapacitors & batteries [ ]
Symposium 7: Nanomaterials for environmental sensing, separation & adsorption [ ]
Category: (Invited / Regular / Student / Young Oral Presentation (< 40 years) Accompanying Person).
Please select appropriate one: [ ]
Arrival Date:
Departure Date:
Amount paid (to pay): [USD]
Welcome reception (Sept. 24 <sup>th</sup> ): Present/Absent
Banquet (Sept. 27 <sup>th</sup> ): Present/Absent

Note: Students must submit a copy of valid student ID card.

Please send this registration form (after filling up) and a copy of bank transfer voucher to the conference chair at <a href="mailto:SHRESTHA.Lokkumar@nims.go.jp">SHRESTHA.Lokkumar@nims.go.jp</a>